PTO/SB/5½' (12-97)
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REISSUE APPLICATION DECLARATION BY THE INVENTOR

501.32049R00

As a below named inventor, I hereby declare that: My residence, post office address and citizenship are stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is described and claimed in patent number 5,637,913 , granted June 10, 1997 , and for which a reissue patent is sought on the invention entitled Leadframe Semiconductor Integrated Circuit Device Using The Same, And Method Of And Process For Fabricating The Two the specification of which is attached hereto.
x was filed on June 9, 1999 as reissue application number 09 / 328,910
and was amended on
(If applicable)
I have reviewed and understand the contents of the above identified specification, including the claims,
as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.
I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)
by reason of a defective specification or drawing.
x by reason of the patentee claiming more or less than he had the right to claim in the patent.
by reason of other errors.
At least one error upon which reissue is based is described as follows:
Patentee claimed less than he had the right to claim as evidenced by the patented claims 1-14 being each directed to a "semiconductor integrated circuit device", whereas any of added claims 15-36 correct such oversight and claim more by each being alternatively directed to a "method of manufacturing a semiconductor device."
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[Page 1 of 2]

Burden Hour Statement: This form is estimated to take 0.5 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231. PTO/SB/51 (12-97)
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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. Docket Number (Optional) (REISSUE APPLICATION DECLARATION BY THE INVENTOR, page 2) 501.32049R00 All errors corrected in this reissue application arose without any deceptive intention on the part of the applicant. As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. Donald R. Antonelli, Reg. No. 20,296; David T. Terry, Reg. No. 20,178; Melvin Kraus, Reg. No. 22,266; William I. Solomon, Reg. No. 28,565; Gregory E. Montone, Reg. No. 28,141; Ronald J. Shore, Reg. No. 28,577; Donald E. Stout, Reg. No. 26,422; Alan E. Schiavelli, Reg. No. 32,087; James N. Dresser, Reg. No. 22,973; Carl I. Brundidge, Reg. No. 29,621 and Paul J. Skwierawski, Reg. No. 32,173 Correspondence Address: Direct all communications about the application to: Place Customer Number Bar 020457 X Customer Number Code Label here Type Customer Number here OR Firm or Individual Name Address Address City ZIP State Country Telephone Fax I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the

I/We hereby claim benefit under Title 35, United States Code, §119 of any provisional application(s) and any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the foreign application(s) on which priority is claimed:

Driagity Claimed

application, any patent issuing thereon, or any patent to which this declaration is directed.

rovisional and/or Foreign Application(s)			Phoney Claime	
4–320098	Japan	30 / 11 /1992	\mathbf{x}	
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
4-71116 (Number)	Japan (Country)	27 / 3 / 1992 (Day/Month/Year Filed)	X	No
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I/We hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I/we acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT internatinal filing date of this application:

(Application Serial No.)	(Filing Date)	(Status: patented, pending, abandoned)
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(Application Serial No.)	(Filing Date)	(Status: patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status: patented, pending, abandoned)

						
(REISSUE APPLICATION DECLARATION BY THE INVEN	Docket Number (Optional)					
		501.32049R00				
Sull name of calcar first investor (-i.e., name for ity name)						
Full name of sole or first inventor (given name, family name) Yujiro KAJIHARA	•					
	Data T	2/ 2/200				
July 12 or Mayimin	Date January 26, 2000					
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Full name of second joint inventor (given name, family name)	-				
Kazunari SUZUKI						
Inventor's signature Kazunari Scizuki	Date	January 26, 2000				
Residence	Citizenship	7 3 11 11 11 11 11 11 11 11 11 11 11 11 1				
Same as Post Office Address	Japan '	·				
Post Office Address 4-20-10, Cyuuou, Oota-ku, Tokyo, Japan						
Full name of third joint inventor (given name, family name)						
Kunihiro TSUBOSAKI Inventor's signature	Data					
Kurihiro Tsubozaki	Date Januar	4 29 2000				
Residence Same as Post Office Address	Çitizenship Japan	<i>d</i>				
Post Office Address	Post Office Address					
2-29-22, Higashihirayama, Hino-shi, Tokyo, Japan						
Full name of sole or 4thinventor (given name, family name)						
Hiromichi SUZUKI Inventor's signature //	Date T					
Hiromichi Silzuki	Ja	nuary 26, 2000				
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Yoshinori MIYAKI						
Inventor's signature Hoshimovi Miyaki	Date ,	January 26, 2000				
Residence	Citizenship	,				
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Inventorssignature	Date	many 21, 2000				
Residence Citizenship Same as Post Office Address Japan		J				
Post Office Address 3-2-40-305, Gakuenhigashi-cho, Kodaira-shi, Tokyo, Japan						
X Additional joint inventors are named on separately num		hereto.				
A J Additional joint inventors are named on separately numbered should addition hereto.						

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(REISSUE APPLICATION DECLARATION BY THE INVENTOR, page 4)		501.32049R00				
Full name of sole or 7th inventor (given name, family name)						
Sueo KAWAI						
Inventor's signature Such Kawai						
Residence	Date Tanuan	4 20. 2000				
Residence Same as Post Office Address Date January 20, 2000						
Post Office Address 1522-49, Ichinoya, Iwama- Citizenship						
machi, Nishiibaraki-gun, Ibaraki, Japan	Japan					
Full name of 8th joint inventor (given name, family name)						
Inventor's signature	Data					
inventor saignature	Date .					
Residence	Citizenship					
Post Office Address						
Full name of 9th joint inventor (given name, family name)						
Inventor's signature	Date					
Residence	Citizenship					
Post Office Address						
Additional joint inventors are named on separately numbered sheets attached hereto.						

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: KAJIHARA et al.

Application: 09/328,910

(Reissue Application of U.S. Patent 5,637,913; issued June 10, 1997)

Filed: June 9, 1999

For: LEADFRAME SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE

USING THE SAME, AND METHOD OF AND PROCESS FOR

FABRICATING THE TWO

Art Unit: 2811

Examiner: Unassigned (parent application's Examiner: J. Clark)

CERTIFICATE UNDER 37 CFR §3.73

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Hitachi, Ltd., a corporation located at 6, Kanda Surugadai 4-chome, Chiyoda-ku,
Tokyo, Japan, and Hitachi ULSI Systems Co., Ltd. (Formerly named Hitachi
Microcomputer System Ltd.), a corporation located at 22-1, Josuihoncho 5-chome,
Kodaira-shi, Tokyo, Japan certifies that they are joint assignees
of the entire right, title and interest in the patent identified above by virtue of an
Assignment (copy attached) which has been recorded in the U.S. Patent and Trademark
Office at Reel 7070, Frame 578-579, and by virtue of a Change of Name document
submitted concurrently herewith (under separate cover letter) for recordation (i.e., the
Change of Name pertaining to a change in corporate name from "Hitachi Microcomputer
System Ltd." to "Hitachi ULSI Systems Co., Ltd.")

The undersigned has reviewed all the documents in the chain of title of the patent application identified above and, to the best of undersigned's knowledge and belief, title is in the assignee identified above.

The undersigned (whose title is supplied below) is empowered and authorized to sign this certificate and consent on behalf of the assignee.

As stated also within the Form PTO/SB/53 filed concurrently herewith, the undersigned assignee of the entire interest in the patent identified above, hereby consents to the accompanying reissue application.

I declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true, and further state that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United

States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: Feb. 10.0000

Date: feb 8, 2000

Hitachi, Ltd.

Mr. Yasuo Sakuta

Executive Managing Director and

Patent Attorney

Intellectual Property Group (Authorized Signing Officer)

Hitachi ULSI Systems Co., Ltd.

Mr. Jinichiro Suzuki

TITLE: President

(Authorized Signing Officer)

Attachment:

copy of original Assignment copy of cover letter and documents regarding Change of Name